

MMSD4148T1G, SMMSD4148T1G, MMSD4148T3G, SMMSD4148T3G



ON Semiconductor®

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Switching Diode

Features

- SOD-123 Surface Mount Package
- High Breakdown Voltage
- Fast Speed Switching Time
- AEC-Q101 Qualified and PPAP Capable
- S Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant*



SOD-123
CASE 425
STYLE 1



MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|--|----------------|-------------|------|
| Continuous Reverse Voltage | V_R | 100 | V |
| Peak Forward Current | I_F | 200 | mA |
| Peak Forward Surge Current (Note 1) | I_{FSM} | 1.0 2.0 | A |
| Operating and Storage Junction Temperature Range | T_J, T_{stg} | -55 to +150 | °C |

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Max | Unit |
|---|-----------------|------------|-------------|
| Total Device Dissipation FR-5 Board (Note 2) $T_A = 25^\circ\text{C}$ Derate above 25°C | P_D | 425 3.4 | mW mW/°C |
| Thermal Resistance Junction-to-Ambient | $R_{\theta JA}$ | 290 | °C/W |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Typical Values
2. FR-5 = 1.0 oz Cu, 1.0 in² pad

MARKING DIAGRAM



- 5I = Device Code
- M = Date Code
- = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

| Device | Package | Shipping† |
|--------------|----------------------|-------------------------|
| MMSD4148T1G | SOD-123 (Pb-Free) | 3,000 / Tape & Reel |
| SMMSD4148T1G | SOD-123 (Pb-Free) | 3,000 / Tape & Reel |
| MMSD4148T3G | SOD-123 (Pb-Free) | 10,000 / Tape & Reel |
| SMMSD4148T3G | SOD-123 (Pb-Free) | 10,000 / Tape & Reel |

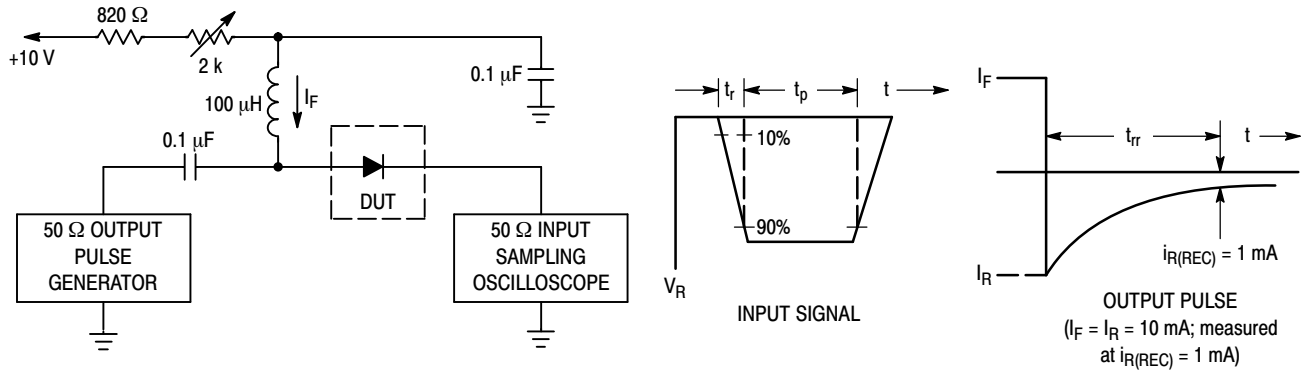
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

| Characteristic | Symbol | Min | Max | Unit |
|---|------------|-----|-----------|---------------------|
| OFF CHARACTERISTICS | | | | |
| Reverse Breakdown Voltage ($I_{BR} = 100 \mu\text{A}$) | $V_{(BR)}$ | 100 | - | V |
| Reverse Voltage Leakage Current ($V_R = 20 \text{ V}$) ($V_R = 75 \text{ V}$) | I_R | - | 25 5.0 | nA μA |
| Forward Voltage ($I_F = 10 \text{ mA}$) | V_F | - | 1000 | mV |
| Diode Capacitance ($V_R = 0 \text{ V}$, $f = 1.0 \text{ MHz}$) | C_D | - | 4.0 | pF |
| Reverse Recovery Time ($I_F = I_R = 10 \text{ mA}$) (Figure 1) | t_{rr} | - | 4.0 | ns |



1. A 2.0 k Ω variable resistor adjusted for a Forward Current (I_F) of 10 mA.
2. Input pulse is adjusted so $I_{R(\text{peak})}$ is equal to 10 mA.
3. $t_p \gg t_{rr}$

Figure 1. Recovery Time Equivalent Test Circuit

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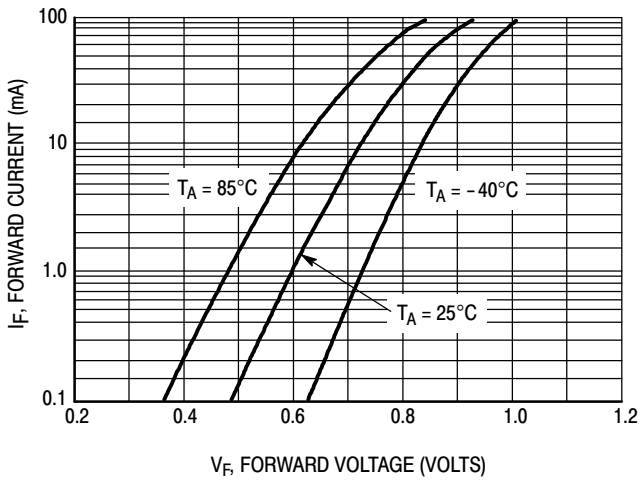


Figure 2. Forward Voltage

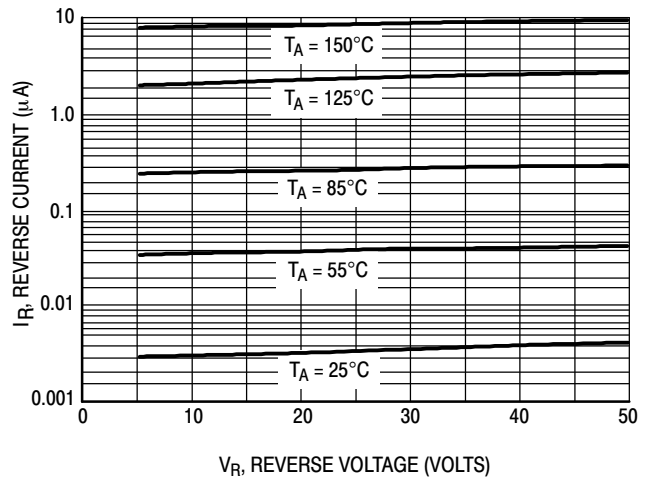


Figure 3. Leakage Current

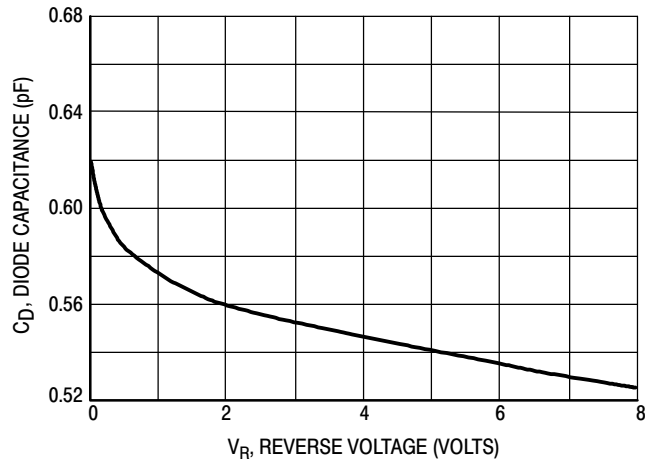
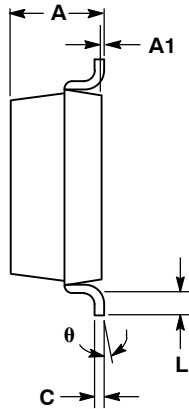
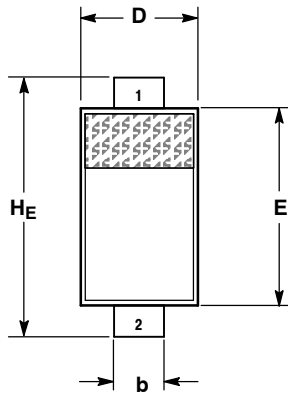


Figure 4. Capacitance

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PACKAGE DIMENSIONS

SOD-123 CASE 425-04 ISSUE G

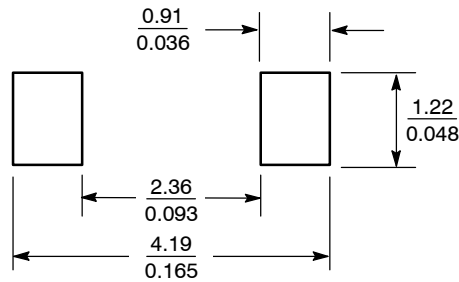


- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

| DIM | MILLIMETERS | | | INCHES | | |
|-----|-------------|------|------|--------|-------|-------|
| | MIN | NOM | MAX | MIN | NOM | MAX |
| A | 0.94 | 1.17 | 1.35 | 0.037 | 0.046 | 0.053 |
| A1 | 0.00 | 0.05 | 0.10 | 0.000 | 0.002 | 0.004 |
| b | 0.51 | 0.61 | 0.71 | 0.020 | 0.024 | 0.028 |
| c | --- | --- | 0.15 | --- | --- | 0.006 |
| D | 1.40 | 1.60 | 1.80 | 0.055 | 0.063 | 0.071 |
| E | 2.54 | 2.69 | 2.84 | 0.100 | 0.106 | 0.112 |
| HE | 3.56 | 3.68 | 3.86 | 0.140 | 0.145 | 0.152 |
| L | 0.25 | --- | --- | 0.010 | --- | --- |
| θ | 0° | --- | 10° | 0° | --- | 10° |

STYLE 1:
PIN 1. CATHODE
2. ANODE

SOLDERING FOOTPRINT*



SCALE 10:1 (mm/inches)

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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